

X0402MH

Datasheet

4 A Sensitive gate SCR in IPAK package



IPAK

Features

- 4 A SCR
- Sensitive SCR: I_{GT} = 200 μA
- + V_{DRM} / V_{RRM} = 600 V and V_{DSM} / V_{RSM} = 750 V
- 125 °C maximum junction temperature Tj
- IPAK package
- Halogen-free molding, lead-free plating
- ECOPACK2 compliant

Applications

Product status link X0402MH

Product summary		
I _{T(RMS)}	4 A	
V _{DSM} /V _{RSM}	750 V	
I _{GT}	200 µA	
T _j max.	125 °C	

Actuators

Ignitors

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Inrush current limiting circuits

Description

The X04 series is 4 A SCR housed in compact through hole IPAK package. This highly sensitive device is suited to home appliances or power tools and industrial systems and drives loads up to 4 A.

1 Characteristics

Symbol	Parameter		Value	Unit	
I _{T(RMS)}	RMS on-state current (full sine wave)	T _c = 114 °C	4	А	
I _{T AV}	RMS on-state average current (full sine wave)	T _c = 114 °C	2.5	А	
land	Non repetitive surge peak on-state current (full cycle,	t = 8.3 ms	33	•	
I _{TSM}	T _j initial = 25 °C)	t = 10 ms	30	A	
l ² t	I ² t value for fusing	t _p = 10 ms	9	A ² s	
dl/dt	$ \begin{array}{l} \mbox{Critical rate of rise of on-state current, } I_G = 2 \ x \ I_{GT}, \ tr} \\ \le 100 \ ns, \ f = 60 \ Hz \end{array} \ T_j = 125 \ ^{\circ}C \ \end{array} $		50	A/µs	
V _{DRM} /V _{RRM}	Repetitive peak off-state voltage $T_j = 125 \degree C$		600	V	
V _{DSM} /V _{RSM}	Non Repetitive peak off-state voltage, 10 ms	750	V		
I _{GM}	Maximum peak gate current		1.2	А	
P _{GM}	$t_p = 20 \ \mu s, \ T_j = 125 \ ^\circ C$		0.5	W	
T _{stg}	Storage temperature range	-40 to +125	°C		
Tj	Operating junction temperature range	-40 to +125	°C		
TL	Maximum lead temperature for soldering during 10 s	260	°C		

Table 1. Absolute maximum ratings (limiting values)

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified)

Symbol	Test conditions			Value	Unit
I _{GT} ⁽¹⁾	$V_{-} = 12 V_{-} P_{-} = 140 O_{-}$	V _D = 12 V, R _L = 140 Ω		200	μA
V _{GT}	$v_{\rm D} = 12 v, R_{\rm L} = 140 \Omega$			0.8	V
V _{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$ $T_j = 125 \text{ °C}$		Min.	0.1	V
V _{RGM}	Ι _{RG} = 10 μΑ		Max.	8	V
ΙL	$I_{G} = 1.2 \times I_{GT}$		Max.	6	mA
I _H ⁽²⁾	I _T = 500 mA, gate open		Max.	5	mA
dV/dt (2)	$V_D = 67 \% V_{DRM}$, $R_{GK} = 1 k\Omega$ $T_j = 110 °C$		Min.	10	V/µs

1. For both polarities of OUT pin referenced to COM pin.

2. For both polarities of A2 referenced to A1.

Table 3. Static characteristics

Symbol	Test conditions	Тј		Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 8 A, t _p = 380 μs	25 °C	Max.	1.8	V
V _{TO} ⁽¹⁾	Threshold voltage	125 °C	Max.	0.85	V
R _D ⁽¹⁾	Dynamic resistance	125 °C	Max.	100	mΩ
	I_{DRM}/I_{RRM} $V_D = V_{DRM}; V_R = V_{RRM}; R_{GK} = 1 k\Omega$	25 °C	Max.	5	μΑ
URM/ IRRM		125°C	ividX.	1	mA

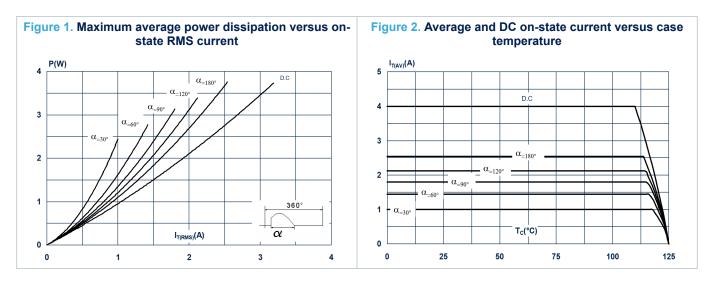
1. For both polarities of A2 referenced to A1.

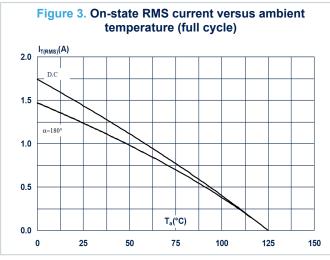
Table 4. Thermal resistance

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case (DC)	Max.	3	°C/W
R _{th(j-a)}	Junction to ambient	Тур.	70	°C/W

1.1 Characteristics (curves)

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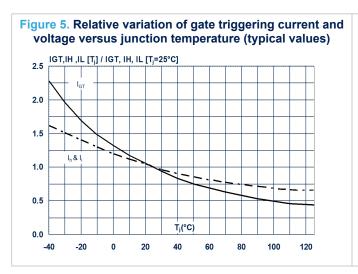
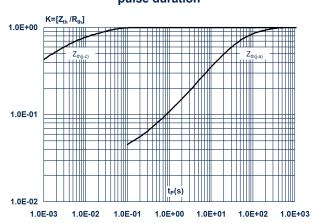
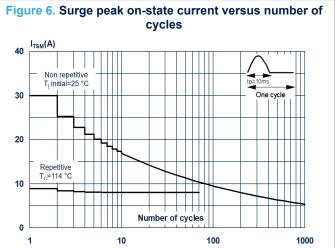
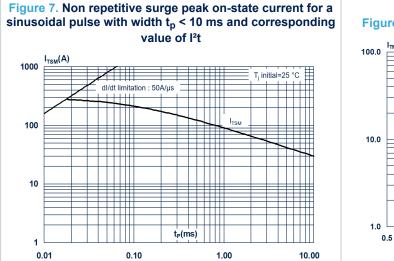


Figure 4. Relative variation of thermal impedance versus pulse duration

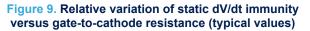


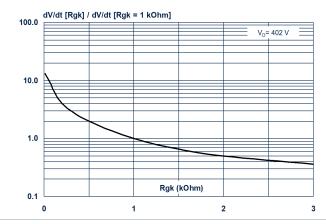






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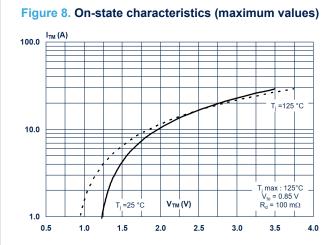
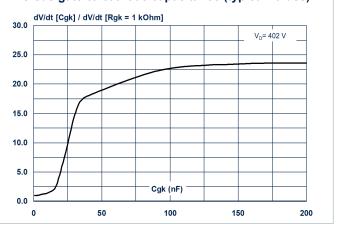


Figure 10. Relative variation of static dV/dt immunity versus gate-to-cathode capacitance (typical values)







2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 IPAK package information

- Molding compouned resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free package leads plating

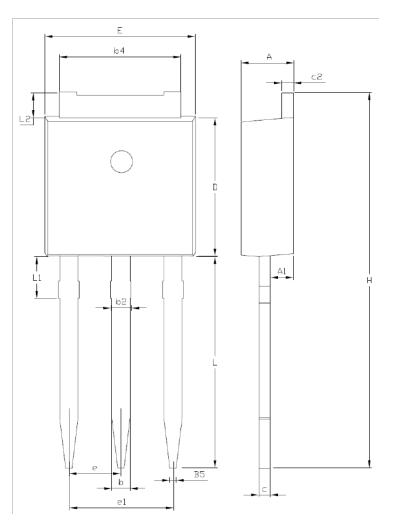


Figure 12. IPAK package outline

Table 5. IPAK package mechanical data

			Dime	nsions			
Ref.	MillimetersInches (for reference only)						
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	2.20		2.40	0.086		0.094	
A1	0.90		1.10			0.035	
b	0.64		0.90	0.025		0.035	
b2			0.95			0.037	
b4	5.20		5.43				
B5		0.30			0.012		
С	0.45		0.60				
c2	0.46		0.60				
D	6		6.20				
E	6.40		6.65	0.252		0.262	
е		2.28			0.090		
e1	4.40		4.60	0.173		0.181	
Н		16.10			0.634		
L	9		9.60	0.354		0.377	
L1	0.8		1.20	0.031		0.047	
L2		0.80	1.25		0.031	0.049	
V1		10°			10°		



3 Ordering information

Figure 13. Ordering information scheme

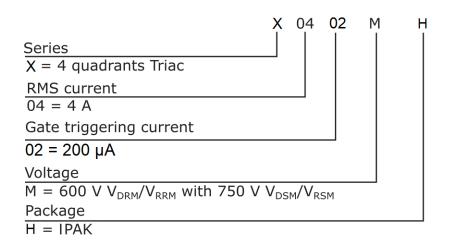


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
X0402MH	X0402MH	IPAK	0.31 g	75	Tube

Revision history

Table 7. Document revision history

Date	Revision	Changes
06-Sep-2022	1	Initial release.

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